

**DESCRIPTION**

LX23108AH - is a compact 8 Ports White or RGB back light LED Driver, to be used in large display notebooks, LCD monitors, and TV sets. It is designed to work together with the LX24132 LED Controller as a chipset, driving up to 32 LED strings with a variable current of up to 200mA peak. In addition, the LX23108AH provides the LX24132 LED Controller with its ports voltage samples, that facilitate the control of the LED strings supply voltage through an external DC/DC converter; minimizing the power dissipation while regulating the LED currents for all 8 strings. Current regulation is maintained within a ± 3 percent.

The LX23108AH LED Driver includes 8 High Bandwidth Current Limiter Cells with PWM Control (ON/OFF Signal).

The chip is designed to operate with external Sense Resistors. Such configuration provides maximum flexibility for system designers when scaling up or down the LED currents for meeting a wide range of high accuracy application requirements.

The LX23108AH LED Driver enables a wide dimming range, achieved through a combination of LED current amplitude and PWM duty-cycle control. In addition, the chipset provides a thermally robust solution through advanced system control; including Drain Voltage Sensing for Open/Shorts events and per string Thermal Protection monitoring.

The LX23108AH LED Driver is housed in a 32 pin, 7mmx7mm QFN package.

KEY FEATURES

- White LED, or RGB Backlight Driver for Large Size Display Panels
- Excellent Thermal Performance
- Up to 8 LED Strings With $\pm 0.5\%$ Precision Current Matching.
- Wide Dimming Ratio with PWM Duty-Cycle and LED Current Amplitude Controls.
- 12 bit PWM Duty-cycle Resolution – Controlled by LX24132, LX24132A or the LX24232 LED Controllers.
- 8 bit Resolution for LED Current Setting – Controlled by LX24132, LX24132A or the LX24232 LED Controllers.
- Open String, Short LED and Over-Temperature Protection Per Individual Channel.

APPLICATIONS

- LCD Monitor and TV
- Large Signage Display

IMPORTANT: For the most current data, consult MICROSEMI's website:

<http://www.microsemi.com>

PACKAGE ORDER INFO

T _A (°C)	MLPQ	Plastic 7 x7mm 32 pin
	RoHS Compliant / Pb-free / MSL 1	
-40 to 85	LX23108AHILQ	
Note: Available in Tape & Reel. Append the letters "TR" to the part number. (i.e. LX23108AHILQ-TR)		

THERMAL DATA

22.5 ° C/W According to the JESD51-7
THERMAL RESISTANCE-JUNCTION TO AMBIENT
Junction Temperature Calculation: $T_J = T_A + (P_D \times \theta_{JA})$. The θ_{JA} numbers are guidelines for the thermal performance of the device/pc-board system. All of the above assume no ambient airflow.

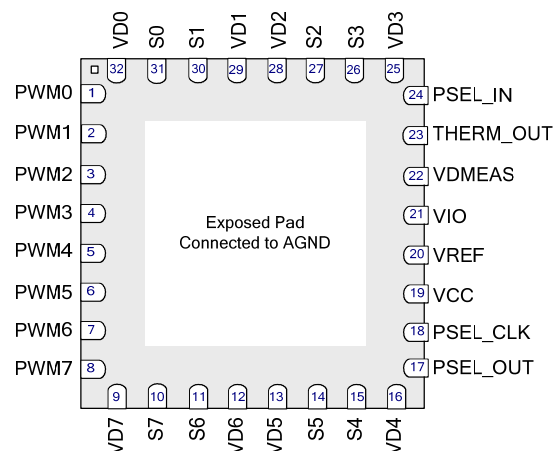


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LX23108AH
8 Ports LED Back Light High Voltage Driver
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ABSOLUTE MAXIMUM RATINGS

V_{CC} Supply Input Voltage -0.5V to 5.5V
 V_{IO} Supply Input Voltage -0.5V to 4.5V
 LED Pins..... -0.3V to 70V
 All other pins -0.5V to $V_{IO}+0.3$ up to 4.5V
 Operating Ambient Temperature Range..... -40 to 85°C
 Maximum Operating Junction Temperature..... 150°C
 ESD Protection at all I/O pins..... +/- 2 kV HBM
 Storage Temperature Range..... -65°C to 150°C
 Package Peak Temperature for Solder Reflow
 (40 seconds maximum exposure) 260°C (+0°C / -5°C)

Notes: Exceeding these ratings could cause damage to the device. All voltages are with respect to Ground. Currents are positive into, negative out of specified terminal.

PACKAGE PIN OUT


(Top View)

RoHS / Pb-free Matte Tin Finish

ELECTRICAL CHARACTERISTICS

The following specifications apply over the operating ambient temperature $-40^{\circ}\text{C} \leq T_{\text{AMB}} \leq 85^{\circ}\text{C}$ except where otherwise noted and the following test conditions: $V_{CC} = 5.0\text{V}$. Performance must be guaranteed for $0^{\circ}\text{C} \leq T_J \leq 110^{\circ}\text{C}$

Parameter	Symbol	Test Conditions / Comment	Min	Typ	Max	Units
Power Supply						
Input Voltage	V_{IO}		3.0	3.3	3.6	V
Operating Current	I_{IO}	$V_{IO} = 3.3\text{V}$, All PWM out are operated at 50% duty @2KHz		1		mA
Input Voltage	V_{CC}		4.5	5	5.5	V
Operating Current	I_{CC}	$V_{CC} = 5\text{V}$, All PWM out are operated at 50% duty @2KHz		7		mA
Digital Interface						
Input Logic High Threshold	V_{HI}		2			V
Input Logic Low Threshold	V_{IL}				0.4	V
Output high voltage	V_{OH}	$I_{OH} = -1\text{mA}$	2.4			V
Output low voltage	V_{OL}	$I_{OH} = 1\text{mA}$			0.4	V
LED Current Control						
Current limiter output accuracy error See Note 1. (Tested @ Room Temp)	ϵ	$40\text{mA} \leq I_{OUT} \leq 80\text{mA}$ @ 100% duty cycle, $175\text{mV} \leq V_{SENSE} \leq 350\text{mV}$ ($R_S = 4.375\Omega$).		± 0.82	± 0.91	%
		$I_{OUT} = 100\text{mA}$ @ 100% duty cycle, $V_{SENSE} = 350\text{mV}$ ($R_S = 3.5\Omega$).			± 0.69	%
		$I_{OUT} = 200\text{mA}$ @ 50% duty cycle,			0.89	%



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Parameter	Symbol	Test Conditions / Comment	Min	Typ	Max	Units
		$V_{\text{SENSE}} = 350\text{mV}$ ($R_{\text{S}} = 1.75\Omega$).				
V_{REF} Range			0		2.5	V
S0-7 Out. Voltage Range			0		357	mV
LED Switching FET $R_{\text{DS-ON}}$		@ 100mA force through LED pin		3.2	5	Ω
Port Switching Output Leakage (I_{LED})		While port is off and $V_{\text{DRAIN}} = 60\text{V}$ $T_{\text{amb}} = 25^{\circ}\text{C}$		0.1	1	μA
Port rise (sense pin) or fall time (drain) – PWM.		@ $V_{\text{MAIN}} = 5\text{V}$, $R_{\text{LOAD}} = 60\Omega$, $C_{\text{LOAD}} = 33\text{pF}$	0.45	0.95	1.7	μS
Port delay - between PWM control and sense voltage increase.		@ 100 mA	0.25	0.6	1.15	μS
		@ 50 mA	0.4	0.95	2	μS
		@ 10 mA	1.2	3.2	7	μS
Protections						
Over Temp. Detection (This parameter is GBD.)	Max Temp	Per Port Thermal Sensor, located @ the driver main LED switching FET – shut off the port if junction Temperature exceed MAX TEMP level	150	180	210	$^{\circ}\text{C}$
Drain Over-voltage Protection Threshold		Shuts a channel off if the V_{d} voltage exceeds this level.	6.0	6.4	6.8	V
ESD – HBM		At all pins - JEDEC JESD22-A114	± 2			kV
ESD - MM		At all pins - JEDEC JESD22-A115-A	± 200			V
ESD - CDM		At all pins - JEDEC JESD22-C101C	± 500			V
Test Mode						
Threshold Voltage at V_{REF}			3.4			V

Note 1: Current accuracy error is calculated according to the below formulas:

$$\varepsilon[\%] = 100 \frac{I_{\text{OUT}} - I_{\text{SET}}}{I_{\text{SET}}}$$

Where the adjusted current is:

$$I_{\text{SET}} = \frac{V_{\text{REF}}}{2.5V} I_{\text{MAX}}$$

$$I_{\text{MAX}} = \frac{2.5V}{7R_{\text{TOTAL}}}$$

$$R_{\text{TOTAL}} = R_{\text{S}} + R_{\text{IC}} + R_{\text{PCB}}$$

I_{OUT} is the observed port current, I_{MAX} is the maximum LED current, R_{S} is the sense resistance, R_{IC} (typically $135\text{m}\Omega$) accounts for the internal resistance at the sense pin and R_{PCB} (typically $15\text{m}\Omega$) represents a parasitic resistance that depends on PCB implementation.



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LX23108AH

8 Ports LED Back Light High Voltage Driver

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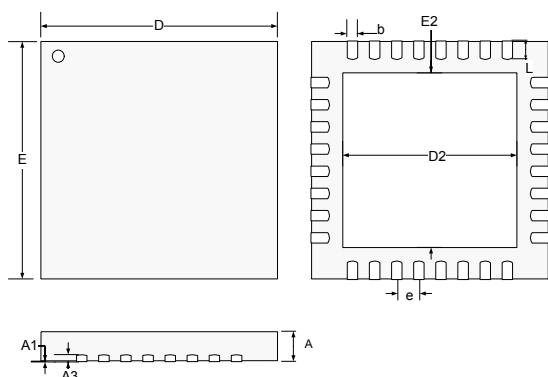
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FUNCTIONAL PIN DESCRIPTION

Name	Pin #	Description
PWM0-7	1-8	Logic Input Signals. Per Port ON/OFF Control When PWM is asserted "0" – LED String is disabled (OFF)
S0-7	31, 30, 27, 26, 15, 14, 11, 10	Current sense pins. These pins are connected to external resistor. The signal from this pin is fed to the LED current regulation amplifier input to maintain the required LED current set by the current reference voltage.
VD0-7	32, 29, 28, 25, 16, 13, 12, 9	Output pins to LED string load. These high voltage output are switched ON/OFF according to the PWM frequency and duty cycle control (PWM input signals). LED Sink Current is Pre-Set by VREF pin
PSEL_IN	24	Serial data input pin. The data from PSEL_IN is clocked into a shift register at the rising edge of the PSEL_CLK. This Serial Data is used to SELECT one VD and one of the Thermal Sensing signals – out to the VDMEAS and THERM_OUT pins.
PSEL_OUT	17	Serial data output pin. The data from the internal shift register is clocked OUT at the rising edge of the PSEL_CLK. This Serial PSEL_OUT - is used to be cascaded into the next LX23108AH Driver – to continue the SELECT functions as described before (VD and Thermal Sensing signals). Through this mechanism – up to 32 Ports can be controlled for VD and Thermal Sense Monitoring.
PSEL_CLK	18	Clock signal for the DIN / DOUT operation. One clock shifts the data by one bit.
VDMEAS	22	Open Drain Output Signal. Port Drain Voltage is multiplexed into this pin, when selected by the internal shift register.
THERM_OUT	23	Open Drain Output Signal. Port Thermal Sensors are latched and multiplexed into this pin, when selected by the internal shift register.
VREF	20	Analog Input signal. This DV voltage, driven by the LX24132, LX24132A or the LX24232 LED Controller, and used to set all LED current levels.
VCC	19	Supply voltage for the internal circuit. A low ESR bypass capacitor not less than 1uF should be placed as close as possible to this pin with low impedance traces to GND
VIO	21	3.3V VIO Supply voltage pin. This voltage is typically used for the I/Os that are communicated with a LX24132, LX24132A or a LX24232 LED Controller.

Package Information

LQ
32-Pin 7x7 mm QFN


Dim	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.80	1.00	0.031	0.039
A1	0	0.05	0	0.002
A3	0.25 REF		0.010	
b	0.23	0.38	0.009	0.015
D	7.00 BSC		0.276 BSC	
D2	5.00	5.25	0.197	0.207
E	7.00 BSC		0.276 BSC	
E2	5.00	5.25	0.197	0.207
e	0.65 BSC		0.026	
L	0.45	0.65	0.018	0.026

Note:

Dimensions do not include protrusions; these do not exceed 0.155 mm (.006") on any side. Lead dimension shall not include solder coverage.

Functional Description

The following sections provide detailed information about the chip, its functions and applications.

LX23108AHILQ Block Diagram

The LX23108AHILQ has eight current limiters controlled by a dedicated reference voltage and by eight independent PWM control signals (received from the LX24132ILQ). The LX23108AHILQ is designed to operate with current scaling external sense resistors connected to its S0 - S7 pins (refer to Figure 1).

Each current limiter employs three components;

- Operational amplifier
- MOSFET
- External sense resistor

These components are utilized to regulate the LED string current to achieve the desired value.

Channels drain voltage measurements are performed at each string's "on" time, in accordance with the PSEL_CLK and PSEL_IN commands received from the LX24132ILQ 32 Port Display Backlight LED Controller. Each output MOSFET has a thermal sensor which causes it to switch off when its temperature exceeds a predetermined value.

At the same time, the channels output voltages are successively sensed for any possible LED short circuit.

Over-Temperature/LED Short-Circuit Events; Latch and Select Operation Description

Each output MOSFET is thermally protected by a temperature sensor that forces its gate to 'Low' in over-heating scenarios (see TP block in Figure 1). Hence, the MOSFET is switched off, regardless of the PWM<n> digital command.

The thermal status of each channel is read by the LX24132ILQ sequentially by utilizing a sampling pulse that clocks the thermal flip-flops at the falling edge. If no thermal event occurs, the flip flop's output is maintained 'Low', as well as its associated AND gate.

When a thermal event occurs the following takes place:

- The set pin of the thermal flip flop is grounded.
- The Q output is asynchronously forced to a 'High'.
- The output of the AND gate is maintained at 'High' unless a sampling pulse is issued.
- However, while Q is at 'High', the amplifier is disabled by an additional AND gate.

The sequential sampling also activates an over-voltage sensing mechanism formed by OV switches, a resistor divider and a voltage comparator. Such comparator is common to all eight ports and reports LED shorts through a general chip OR gate.

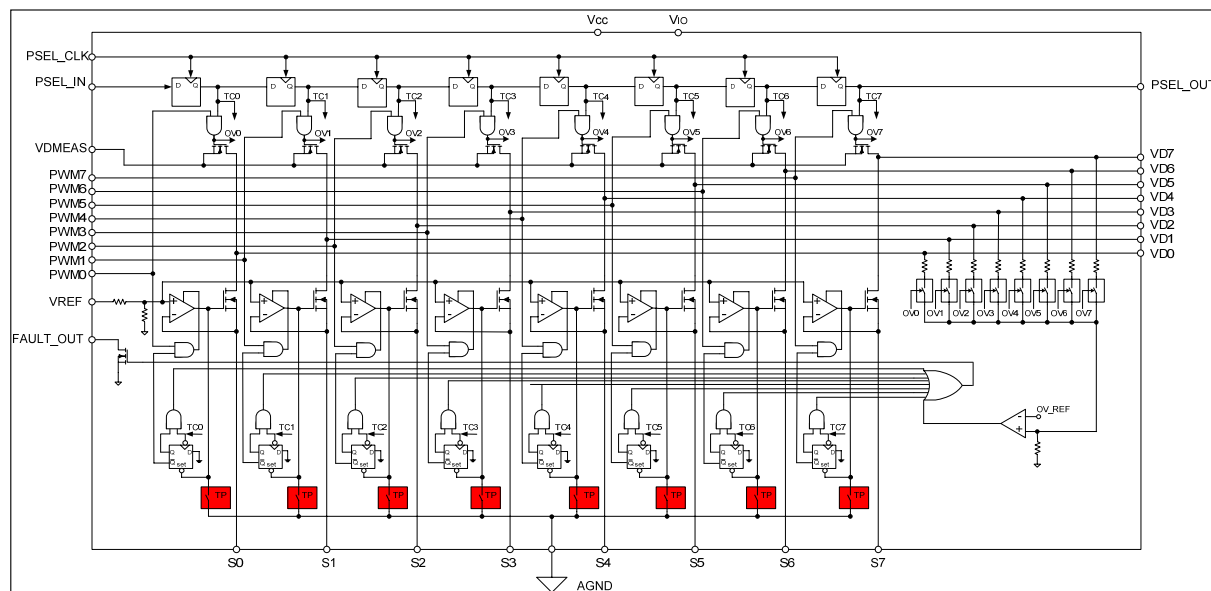


Figure 1: LX23108AHILQ Block Diagram

Current Sense Resistor Selection

The value of the external sense resistors is determined as shown below:

$$R_{SENSE} = \frac{V_{REF_MAX}}{7 \cdot I_{MAX}} - R_{IC} - R_{PCB}$$

V_{REF_MAX} is equal to 2.5V; it is the maximum reference voltage.

I_{MAX} is the maximum LED current.

R_{IC} and R_{PCB} are internal IC and PCB resistances, respectively. Typically, R_{IC} is 85 mΩ and R_{PCB} is 15 mΩ.

Power Dissipation Calculation

The power dissipated by the LX23108AHILQ 8-port LED driver is calculated as follows:

$$P_D = V_{CC}I_{CC} + V_{IO}I_{IO} + I_{OUT} \cdot \sum_K V_{DS_K} \cdot D_K$$

I_{OUT} is the output current.

V_{DS_K} and D_K are the drain-source voltage and PWM duty-cycle at channel "K".

Drain Measurements and Select Operation Description

A logic circuitry within the LX23108AHILQ enables the LX24132ILQ to sequentially measure all the array drain voltages and stores the results in internal registers.

The measurements are performed when appropriate commands (determined by the PSEL_IN and PSEL_CLK) are received from the LX24132ILQ at each string's "on" time.

The System Controller uses this information in conjunction with its algorithms to calculate the power dissipation and control the power supply voltage (see Figure 2).

Fault Detection and Protection

The LX23108AHILQ, in conjunction with the LX24132ILQ, has fault detection and protection feature dedicated for an open LED string, short LED and over-temperature (see Figure 2). The open string and short LED faults are detected one by one in such a way that if a fault is detected at a specific stage, it can be shut down individually without affecting the operation of the other LEDs.

The over-temperature protection circuits monitor the die temperature and shut down the relevant channel when temperature reaches a trigger point (See Figure 1 and Figure 2). Such channel returns to normal operation when the temperature drops below the recovery threshold.

Typical Application

As shown in Figure 2, 32 LED strings are supported by a single LX24132ILQ 32 Port Display Backlight LED Controller and four LX23108AHILQs arrays (eight ports each).

Typical applications include:

- LCD display back-lighting
- LED signboards
- LED displays

The System Controller (LED BL FPGA) controls the general modes and sets the parameters for the operation of the LX24132ILQ devices used in the system. The LX24132ILQ sequentially measures the voltages of all LX23108AHILQ 8-port LED driver's channels.

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The System Controller performs various calculations based on each LX24132ILQ measurement. Measurements and status information are available in registers within the LX24132ILQ digital block that are accessed through a designated SPI communication bus (see Figure 2).

Therefore, bi-directional information between the system Controller and the LX24132ILQ flows via the SPI communication protocol.

The LX24132ILQ controls the BackLight LED currents by driving the LX23108AHILQ 8-port LED drivers with an accurate voltage reference. Hence, the LX23108AHILQs generates accurate currents for LED strings, up to eight strings per array chip.

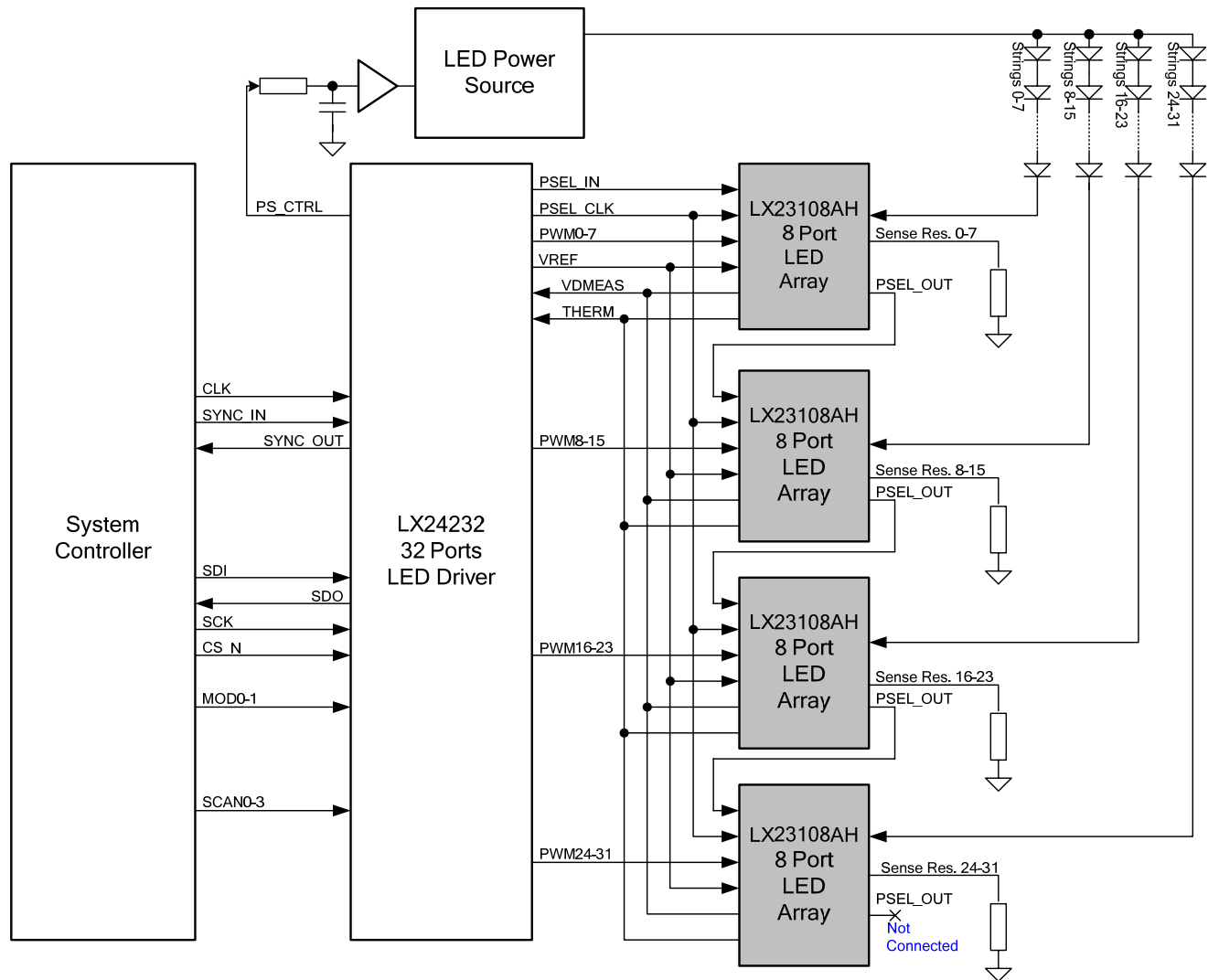


Figure 2: Low Voltage LED Controller and 8 Channel LED Driver

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LX23208

LX23108AH

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Revision History

Revision Level / Date	Para. Affected	Description
1.0 / October 2010	-	Initial Release
1.1 / Jan 2011	-	Update Rsense Calculaiton Offset
1.2 / March 2011	-	OVP update
1.3 / May 2011	-	General update
1.4 / March 2012	-	Added symbols to a few characteristics

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